

As a below-named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention titled:

SEMICONDUCTOR MULTI-PACKAGE MODULE HAVING INVERTED SECOND PACKAGE STACKED OVER DIE-UP FLIP-CHIP BALL GRID ARRAY (BGA) PACKAGE

| the specification of which | ch | |
|---|---|---|
| is attached | | |
| _ | n 08 October 2003 as Applic | eation No. 10/681 747 |
| | | |
| and wa | as amended on (<i>if applica</i> | DIE). |
| | | and understand the contents of the above-identified any amendment referred to above. |
| application in accordan "Each individual associ good faith in dealing wi that individual to be ma known to be material is patentability of any clai prescribed by §§ 1.97(i) I hereby claim application(s) for pater foreign application for pater | ce with Title 37, Code of Fed lated with the filing and pros lith the Office, which includes aterial to patentability as defi to patentability is deemed to m issued in a patent was cite b)-(d) and 1.98." foreign priority benefits und not or inventor's certificate a patent or inventor's certificate | rmation which is material to the examination of the deral Regulations, § 1.56(a) which states in relevant particular and the decution of a patent application has a duty of candor and a duty to disclose to the Office all information known to ined in this sectionThe duty to disclose all information be satisfied if all information known to be material the deduction of the Office or submitted to the Office in the manner deferment of the Title 35, United States Code, § 119 of any foreign is indicated below and have also identified below are on this invention having a filing date before that of the |
| application on which pr | ority is claimed: | · |
| Prior Foreign A | Priority Claimed | |
| | | ☐ Yes ☐ No |
| (Number) (Co | untry) (Day/Month/Year File | |
| | | ☐ Yes ☐ No |
| (Number) (Co | untry) (Day/Month/Year File | ed) |
| application(s), and ur application(s), listed be disclosed in the prior I United States Code, § Code of Federal Regul | nder Title 35, United State flow and, insofar as the subj United States application in 112, I acknowledge the dut | 5, United States Code, § 120 of any United States Code, § 119(e) of any United States provisional ect matter of each of the claims of this application is not the manner provided by the first paragraph of Title 33 y to disclose material information as defined in Title 33 urred between the filing date of the prior application and pplication: |
| 60/447.077 | 0.000 | Abandanad |
| 60/417,277 (Application No | 8 October 2002 o.) Filing Date) | <u>Abandoned</u> (Status: Patented, Pending, Abandoned) |
| 60/460,541 | 04 April 2003 | Pending |
| (Application N | | (Status: Patented, Pending, Abandoned) |

| | O7 July 2003 Pending (Filing Date) (Status: Patented, Pending, Abandoned) lowing attorney(s) and/or agent(s) to prosecute this application and transactorized therewith, and to file, prosecute and to transactorized therewith, and to file, prosecute and to transactorized therewith. |
|--|--|
| | international applications directed to said invention: |
| | Beffel, Jr. Reg. No. 43,489 S. Wolfeld Reg. No. 31,454 . Hann Reg. No. 29,719 |
| Address all correspondence to | |
| Bill Kennedy Haynes Beffel & Wolfeld P.O. Box 366 Half Moon Bay, CA 940 | |
| Direct all telephone calls to B | ill Kennedy at (650) 712-0340. |
| statements made on informati made with the knowledge that imprisonment, or both, under | all statements made herein of my own knowledge are true and that a on and belief are believed to be true; and further that these statements were willful false statements and the like so made are punishable by fine of Title 18, United States Code, § 1001 and that such willful false statement he application or any patent issued thereon. |
| Full name of sole or first | Manage Kamaga |
| inventor: | Marcos Karnezos |
| Inventor's signature: | Maryon |
| Date: | 1/23/04 |
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Same as above

Residence: